MMG75HB120H6HN

1200V 75A Four-Pack Module

May 2015 **Version 01** **RoHS Compliant**

PRODUCT FEATURES

☐ High short circuit capability,self limiting short circuit current

☐ IGBT CHIP(T4 Fast Trench+Field Stop technology)

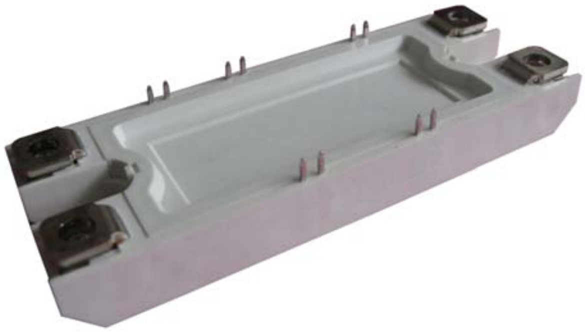
☐ $V_{CE(sat)}$ with positive temperature coefficient

☐ Fast switching and short tail current

☐ Free wheeling diodes with fast and soft reverse recovery

☐ Low switching losses

☐ T_{Jmax} =175°C



APPLICATIONS

☐ High frequency switching application

☐ Medical applications

☐ Motion/servo control

☐ UPS systems

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS(*T_C=25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	T_J=25℃	1200	V
V_{GES}	Gate Emitter Voltage		±20	
I_C	DC Collector Current	T_C=25℃	100	A
		T_C=95℃	75	
I_{CM}	Repetitive Peak Collector Current	tp=1ms	150	
P_{tot}	Power Dissipation Per IGBT		465	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS *(T_C=25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	T_J=25℃	1200	V
$I_{F(AV)}$	Average Forward Current	T_C=25℃	75	A
I_{FRM}	Repetitive Peak Forward Current	tp=1ms	150	
I^2t		T_J=125℃, t=10ms, V_R=0V	1150	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions			Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	V_{CE}=V_{GE}, I_C=3mA		5.4	6.0	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	I_C=75A, V_{GE}=15V, T_J=25℃			2.1	2.5	
		I_C=75A, V_{GE}=15V, T_J=125℃			2.5		
I_{CES}	Collector Leakage Current	V_{CE}=1200V, V_{GE}=0V, T_J=25℃				1	mA
		V_{CE}=1200V, V_{GE}=0V, T_J=125℃				10	mA
I_{GES}	Gate Leakage Current	V_{CE}=0V,V_{GE}=±15V, T_J=25℃		-400		400	nA
R_{gint}	Integrated Gate Resistor				10		Ω
Q_g	Gate Charge	V_{CE}=600V, I_C=75A , V_{GE}=15V			0.35		µC
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f =1MHz			4.4		nF
C_{res}	Reverse Transfer Capacitance				240		pF
$t_{d(on)}$	Turn on Delay Time	V_{CC}=600V,I_C=75A R_G =10Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		150		ns
			T_J=125℃		160		ns
			T_J=150℃		170		ns
t_r	Rise Time		T_J=25℃		60		ns
			T_J=125℃		65		ns
			T_J=150℃		70		ns
$t_{d(off)}$	Turn off Delay Time	V_{CC}=600V,I_C=75A R_G =10Ω, V_{GE}=±15V, Inductive Load	T_J=25℃		360		ns
			T_J=125℃		400		ns
			T_J=150℃		420		ns
t_f	Fall Time		T_J=25℃		40		ns
			T_J=125℃		60		ns
			T_J=150℃		70		ns
E_{on}	Turn on Energy	V_{CC}=600V,I_C=75A R_G =10Ω, V_{GE}=±15V, Inductive Load	T_J=125℃		10		mJ
			T_J=150℃		11		mJ
E_{off}	Turn off Energy		T_J=125℃		4.5		mJ
			T_J=150℃		4.8		mJ
I_{SC}	Short Circuit Current	tpsc≤10µS , V_{GE}=15V T_J=125℃,V_{CC}=600V			300		A
R_{thJC}	Junction to Case Thermal Resistance （ Per IGBT）					0.32	K /W

Diode-inverter

ELECTRICAL CHARACTERISTICS *(T_C =25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	I_F=75A , V_{GE}=0V, T_J=25℃		1.65	2.15	V
		I_F=75A , V_{GE}=0V, T_J=125℃		1.65		
t_{rr}	Reverse Recovery Time	I_F=75A , V_R=600V dI_F/dt=-1650A/µs T_J =125℃		450		ns
I_{RRM}	Max. Reverse Recovery Current			65		A
Q_{RR}	Reverse Recovery Charge			13.5		µC
E_{rec}	Reverse Recovery Energy			5.1		mJ
R_{thJCD}	Junction to Case Thermal Resistance （ Per Diode）				0.6	K /W

NTC CHARACTERISTICS *(T_C=25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
R_{25}	Resistance	T_C =25℃		5		KΩ
$B_{25/50}$	$R_2 = R_{25}$ exp $[B_{25/50}(1/T_2$ - 1/(298.15 K))]			3375		K

MODULE CHARACTERISTICS *(T_C=25°C unless otherwise specified)*

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		175	℃
T_{Jop}	Operating Temperature		-40~150	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
Torque	to heatsink	Recommended（M6）	3~5	Nm
	to terminal	Recommended（M5）	2.5~5	Nm
Weight			200	g

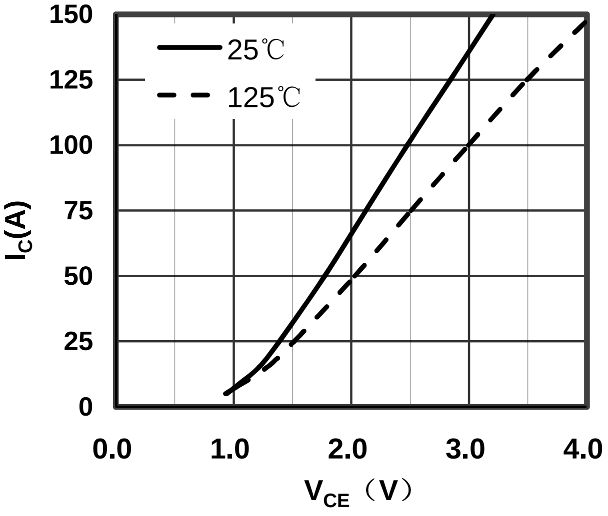


Figure 1. Typical Output Characteristics IGBT-inverter

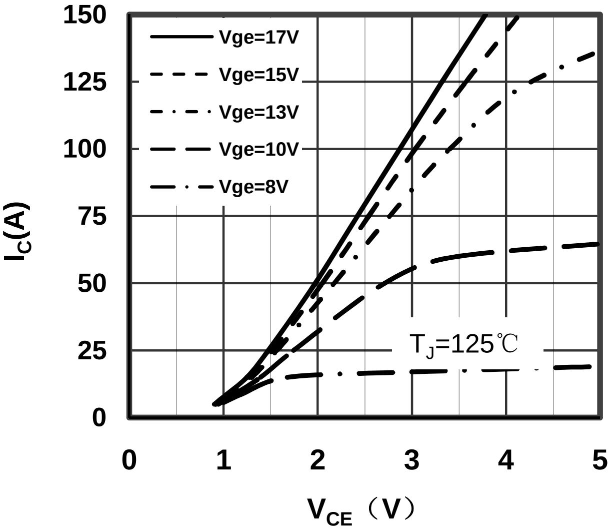


Figure 2. Typical Output Characteristics IGBT-inverter

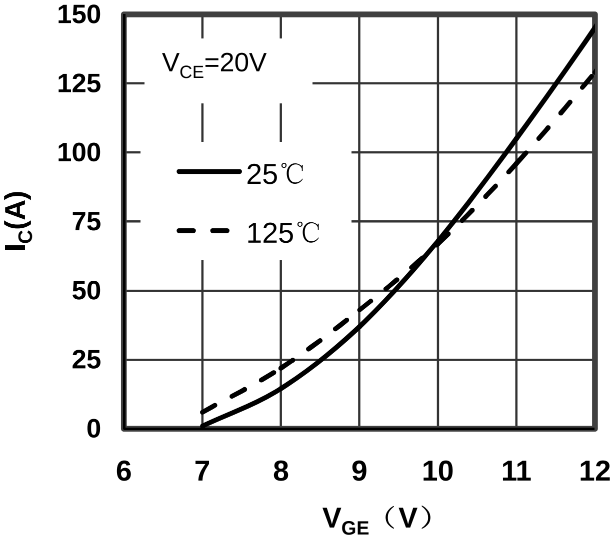


Figure 3. Typical Transfer Characteristics IGBT-inverter

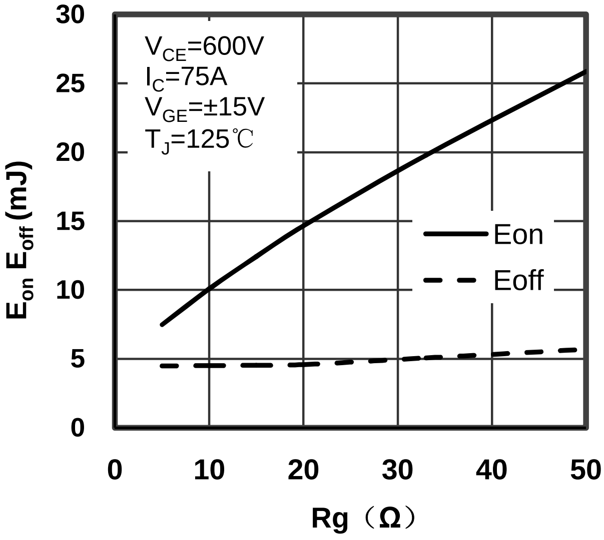


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

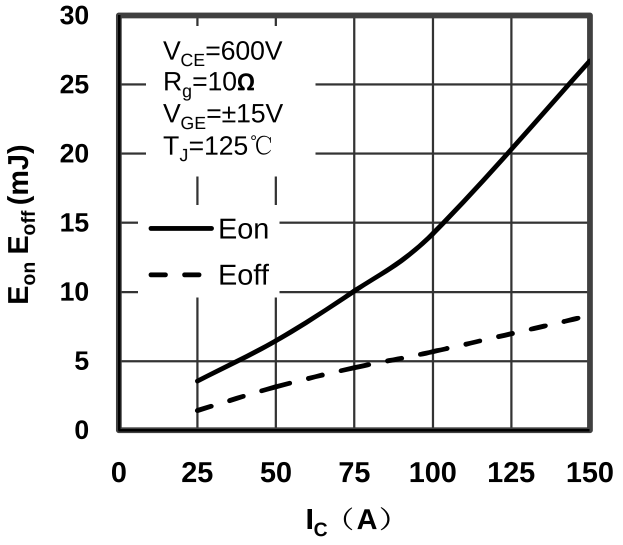


Figure 5. Switching Energy vs Collector Current IGBT-inverter

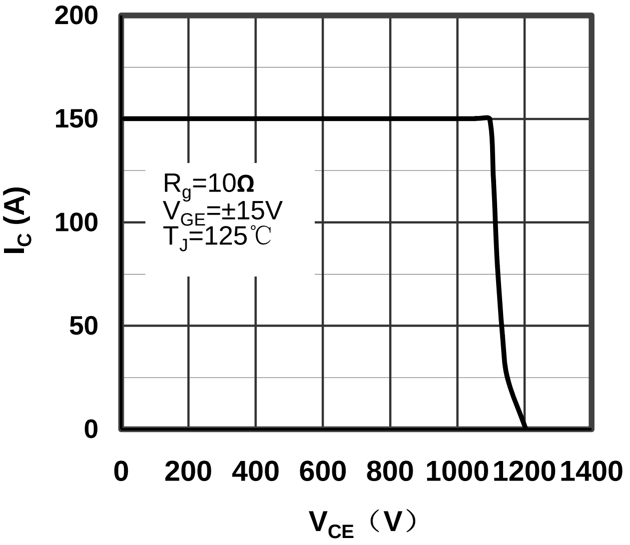


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

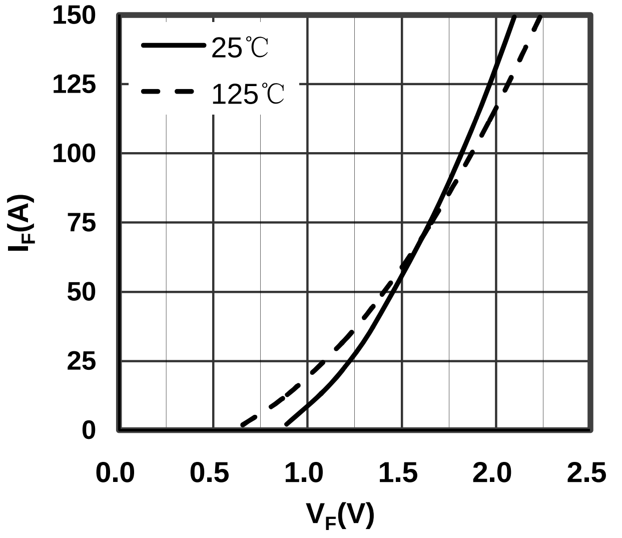


Figure 7. Diode Forward Characteristics Diode -inverter

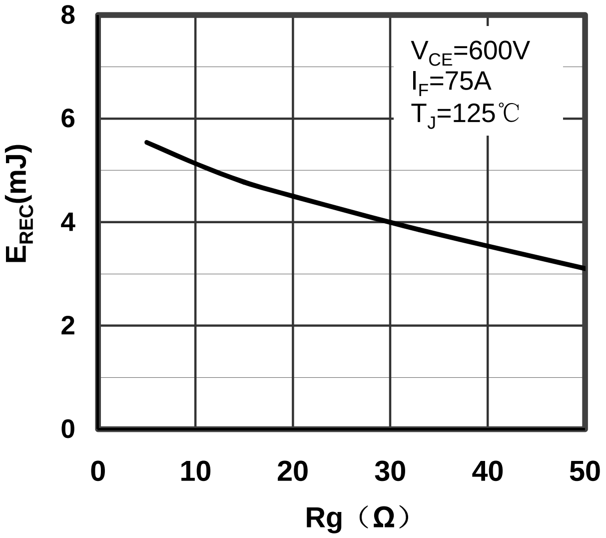


Figure 8. Switching Energy vs Gate Resistor Diode -inverter

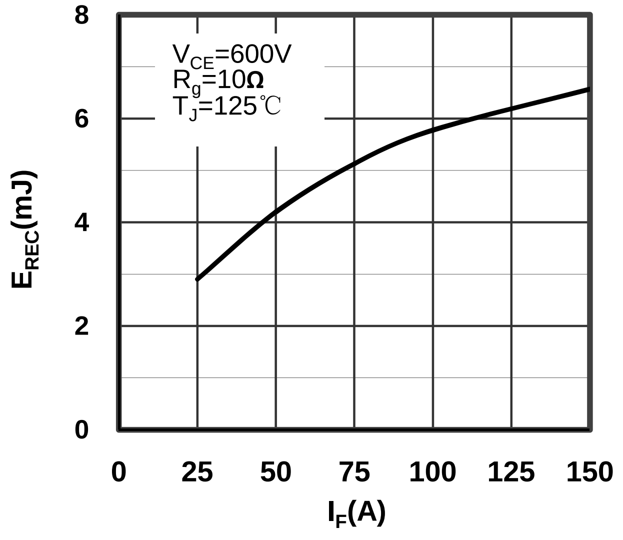


Figure 9. Switching Energy vs Forward Current Diode-inverter

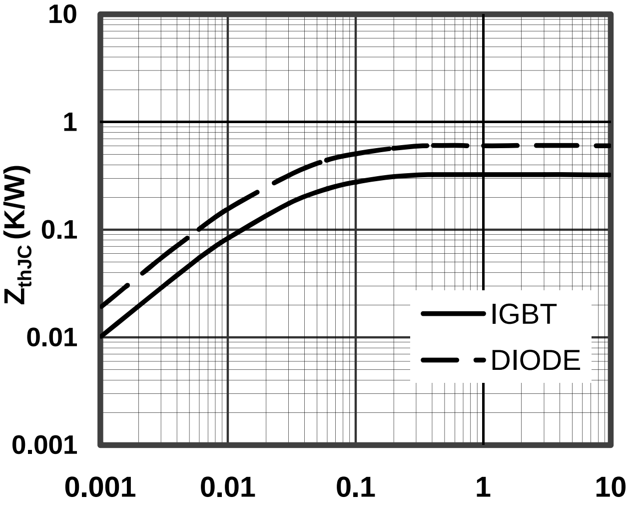


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

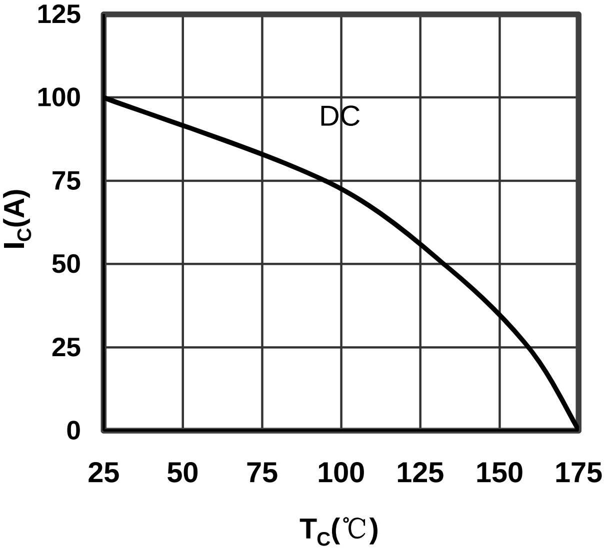


Figure 11. Collector Current vs Case temperature IGBT -inverter

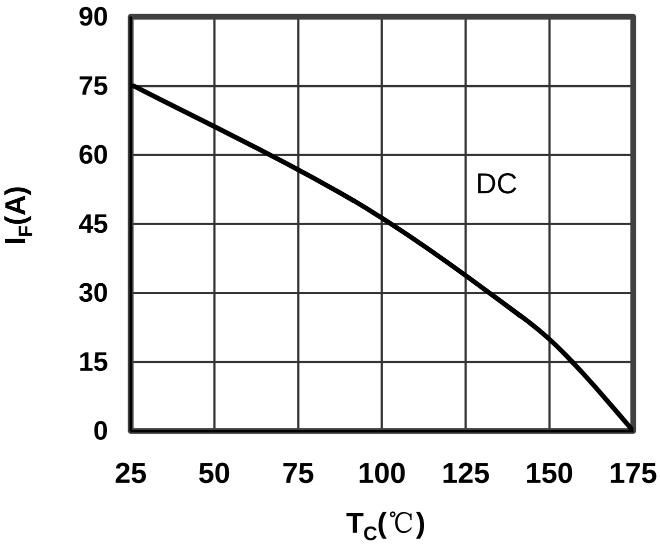


Figure 12. Forward current vs Case temperature Diode -inverter

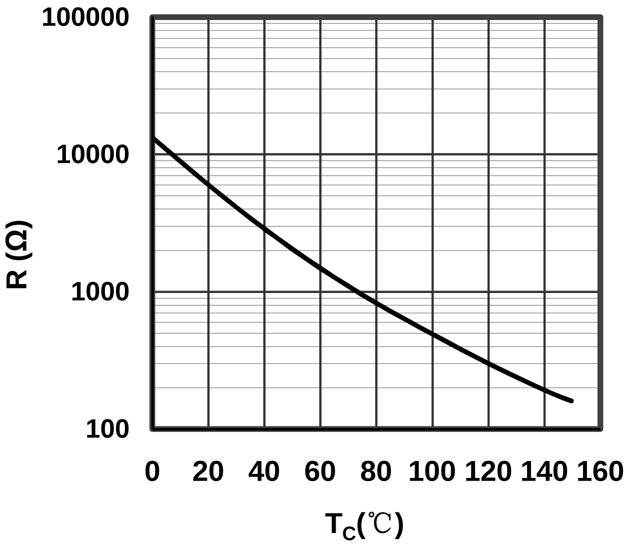


Figure 13. NTC Characteristics

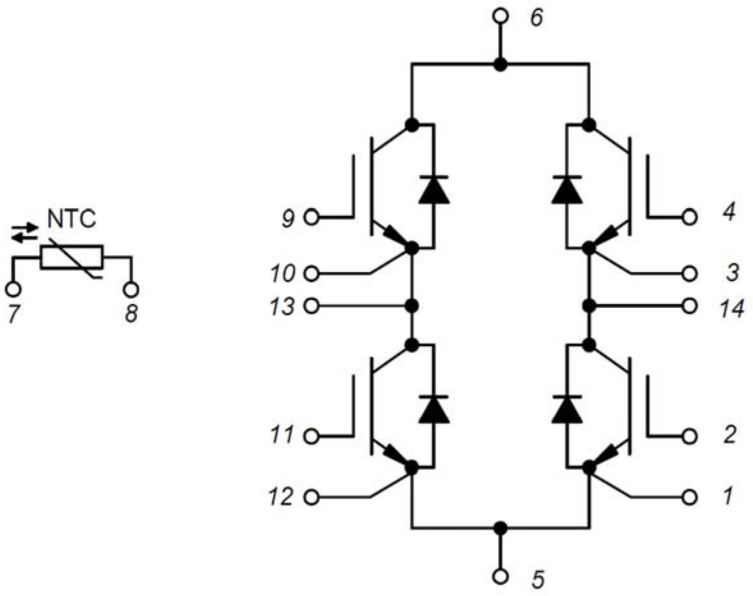
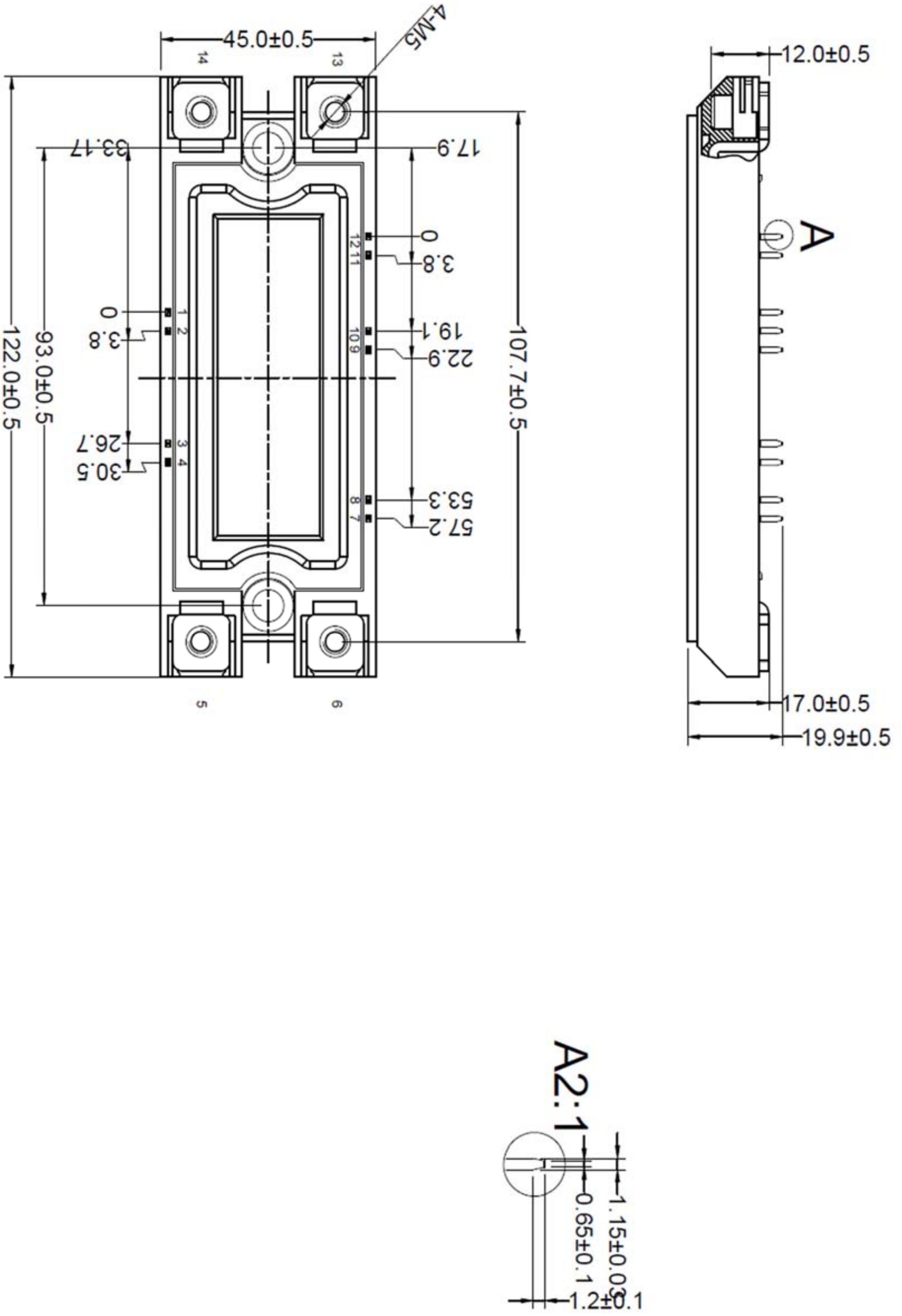


Figure 14. Circuit Diagram



Dimensions in (mm)

Figure 15. Package Outline